# PRODUCT / PROCESS CHANGE NOTIFICATION

Generic Copy
PCN#2311001 • DATE: 16 <sup>th</sup> November, 202
PCN Subject: Change Assembly Site for Package DFN Series
<ul> <li>PCN Change Category:</li> <li>■ Material</li> <li>■ Process</li> <li>□ Datasheet/Specification</li> <li>□ Reliability</li> <li>■ Others ( New assembly site )</li> </ul>
Description of Change Purpose or Reason:
This PCN is being issued to announce the qualification of PANJIT
Semiconductor (Xuzhou) Co., Ltd (located in Jiangsu Province, China) as an
assembly and test site for DFN series selected products. The products that will be

Semiconductor (Xuzhou) Co., Ltd (located in Jiangsu Province, China) as an assembly and test site for DFN series selected products. The products that will be manufactured from this new assembly/test site are form, fit, and function compatible with the current qualified manufacturing sites. The qualification incorporates new bill of material (BOM) sets including the utilization of High-Density Leadframe with copper material, the change of wire type and wire diameter. For more detail, please check below change information.

We recommend that you acknowledge receipt of this notification within 30 days of this PCN date. If you require samples for further evaluation, please feel free to contact your local sales representative and make a request. We are always pleased to serve you at any time.

	Compariso	n	Table 1			
			From (Current)	Change to (New)		
Assembly Site		PANJIT International Inc.	PANJIT Semiconductor (Xuzhou) Co., Ltd.			
Р	Production Site Location		Kaohsiung, Taiwan	Xuzhou, China		
	Package		DFN 2L	DFN1006-2L		
	Packing		8 kpcs / reel	10 kpcs / reel		
	Lead Frame	Material	Copper	Copper (NiPdAu plated)		
	Die Attach (Epoxy)	Material	Ablestik 84-1LMISR4	5002BG-6		
	Wire	Material / Diameter (mil)	Au / 0.8	PdAuCu / 0.8		
	Epoxy Molding Compound	Type Name	ELER-8-100HFS CEL-9240HF	EME-G770HCD		
Material	Carrier Tape	Material	Polycarbonate (PC)	Polycarbonate (PC)		
	Ending tape	Material	Polyester	Paper		
	Ending tape	Color	Black	Yellow		
	Blue Anti-Static Plastic Reel					
<b>N</b> 4-41 - 1		De-Flash	None	Chemical De-flash		
Method	Process	Lead Plating	Sn	None		
	Marking format		BZ	Add bar "-" for new assembly site		
Form	Bottom View		Lead color: Silver	Lead color: Gold		
	Side View					

	Compariso	n	Table 2			
			From (Current)	Change to (New)		
Assembly Site		PANJIT International Inc.	PANJIT Semiconductor (Xuzhou) Co., Ltd.			
Р	roduction Site L	ocation	Kaohsiung, Taiwan	Xuzhou, China		
	Package		DFN 3L	DFN1006-3L		
	Packing		8 kpcs / reel	10 kpcs / reel		
	Lead Frame	Material	Copper	Copper (NiPdAu plated)		
	Die Attach (Epoxy)	Material	Ablestik 84-1LMISR4	5002BG-6		
	Wire	Material / Diameter (mil)	Au / 1.0	PdAuCu / 0.8		
	Epoxy Molding Compound	Type Name	ELER-8-100HFS CEL-9240HF	EME-G770HCD		
Material	Carrier Tape	Material	Polycarbonate (PC)	Polycarbonate (PC)		
	For the section of		Polyester	Paper		
	Ending tape	Color	Black	Yellow		
	Blue Anti-Static Plastic Reel					
Method	Process	De-Flash	None	Chemical De-flash		
Wethou	FIOCESS	Lead Plating	Sn	None		
	Marking format		U3.	Add bar "-" for new assembly site		
Form	Bottom View		Lead color: Silver	Lead color: Gold		
	Side View		D D	a a a a a a a a a a a a a a a a a a a		

Comparison	From (C	Current)	Change to (New)		
Package	DFN	l 2L	DFN1006-2L		
Package Outline Drawing Dimension	e1 L A1		e1 L A1 e1 L b		
Symbol (mm)	Min Max		Min	Max	
L	0.22	0.32	0.20	0.30	
Pad Layout	B +		A +		
Symbol (mm)	Dime			nsion	
С	0.4			40	
D	0.0	68	0.	70	



Comparison	From (C	Current)	Change	to (New)	
Package	DFN		DFN10		
Package Outline Drawing Dimension	D b2-A1	Le1 L b1	b2 A	b1	
Symbol (mm)	Min	Max	Min	Max	
L	0.22 0.32		0.20	0.30	
е	0.36		0.35 ref		
e1	0.36 ref		0.40 ref		
Pad Layout	В		F		
Symbol (mm)	Dime	nsion	Dimension		
Α	1.10		1.15		
С	0.42		0.45		
D	0.68		0.70		
E	0.38		0.45		
F	0.4		0.45		
G	0.2	22	0.2	25	



Carrier Tape	From (C	Current)	Change to (New)		
Assembly Site	PANJIT PANJIT Semiconductor (Xuzhou) Co., Ltd.		_		
Package	DFN 2L	DFN 3L	DFN1006-2L	DFN1006-3L	
Dimension	Po P2  Do				
Symbol (mm)	Dimension		Dime	nsion	
Ao	$0.72 \pm 0.05$		$0.69 \pm 0.05$		
Во	1.12 ± 0.05		1.19 ± 0.05		
Ko	0.62 ± 0.05		$0.63 \pm 0.05$		
D1	0.50 =	± 0.05	$0.40 \pm 0.10$		

#### Verification /Qualification Data:

The electrical characterization and high reliability testing have been completed on representative part numbers to ensure there is no change to device functionality or electrical specifications in the datasheet. There will be no change to the Form, Fit, or Function of products affected.

#### • Affected Product Type:

Table 1: Change assembly site from PANJIT International Inc. to PANJIT Semiconductor (Xuzhou) Co., Ltd.

Wire Material	Wire Diameter (mil)	Function: Small Signal Switching Diodes		Diodes	
Au	0.8	1SS387FN2			

Table 2: Change assembly site from PANJIT International Inc. to PANJIT Semiconductor (Xuzhou) Co., Ltd.

Wire Material	Wire Diameter (mil)	Function: Bipolar Junction Transistors		
Au	1.0	BC847BFN3	MMBT3904FN3	MMBT3906FN3

• Effective Date: 16<sup>th</sup> February, 2024

### > The reliability test results are summarized below:

Product reliability test result: PASS

No.	DESCRIPTION	TEST CONDITION	DURATION	FAIL	URE RATE
1	Temperature Cycling (TCT)	Ta = -55°C ~ +150°C ( 2 cycles / Hour )	1000 CYCLES	0/77 PCS	3 LOTS PASS
2	High Temperature Storage Test (HTSL)	Ta = 150°C	1000 HOURS	0/77 PCS	3 LOTS PASS
3	Resistance to Solder Heat (RSH)	Temperature of solder pot = $260 \pm 5^{\circ}$ C Time for dipping in solder = $10 + 2/-0$ Sec	1 CYCLE	0/30 PCS	3 LOTS PASS
4	Solder ability (SD)	Temperature of solder pot = $245 \pm 5^{\circ}$ C Time for dipping in solder = $5 \pm 0.5$ Sec	1 CYCLE	0/10 PCS	3 LOTS PASS
5	Intermittent Forward Operation Life (IFOL)	△Tj≥100°C Power On: 120 sec Power Off: 120 sec	15000 CYCLES	0/77 PCS	3 LOTS PASS
6	High Temperature Reverse Bias (HTRB)	Ta = 140°C , VR = 80%VB, DC supply	1000 HOURS	0/77 PCS	3 LOTS PASS
7	Autoclave (AC)	Ta = 121°C, P = 29.7psia ,100%RH	96 HOURS	0/77 PCS	3 LOTS PASS
8	Temperature Humidity Storage (THS)	Ta = 85°C , RH = 85%	1000 HOURS	0/77 PCS	3 LOTS PASS

# • ELECTRICAL CHARACTERISTICS SUMMARY:

There is no change to the product electrical specifications.

#### • SAMPLES NEED:

Contact your local PANJIT sales representative.

#### • TECHNICAL CONTACT:

E-mail: jwchen@panjit.com.tw

#### • FOR ANY QUESTIONS CONCERNING THIS NOTIFICATION:

Contact your local PANJIT sales representative.

#### • ADDITIONAL RELIABILITY:

Contact your local PANJIT sales representative.

#### • CHANGED PART IDENTIFICATION:

The tracking of 1<sup>st</sup> delivery after change can be identified by production lot number. Please contact your local sales for tracking lot number.

Please refer to below Lot number rule:

Lot number: 3924XXXXX.

1st digit "3" denotes Year 2023. 2nd digit "9" denotes September. 3rd and 4th digits denote Day.

From 5<sup>th</sup> digits (XXXXX) denotes production serial number.

### **Customer Acknowledgement Form**

(To be filled out by the customer and returned to HQBU of PANJIT)
The indicated Customer Notification letter was received and acknowledged by the undersigned authority.
Company Name :
Customer Name :(Signature) Date :
PCN Number : PCN# 2311001
Approval for the Product/Process change:   Yes   No
Comments/Additional requests:
Thanks for your attention on this matter. Please return the acknowledgment form to your local

PANJIT sales representative.

Please note that no objection within 30 days upon receiving will be deemed as being accepted and agreed with this Process Change Notification.